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Law Office of Michael A. Sanzo, LLC

Practice Limited to Patent Law

December 31, 2007

Commissioner of Patents
U.S. Patent and Trademark Office
Customer Service Window, MS Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Re: Third Supplemental Information Disclosure Statement
Appl. No.: 10/591,289
Filed: August 31, 2006
Title: **High Transparency Laser-
Markable and Laser-Weldable
Plastic Materials**
Inventor(s): Häger, *et al.*
Atty. Dkt.: 7601/88288

Dear Sir:

The following documents are being forwarded herewith for appropriate action by the U.S. Patent and Trademark Office:

1. Third Supplemental Information Disclosure Statement;
2. PTO/SB/08a (list of references);
3. References B1-B8, C1-C5; and
4. Return Postcard.

Applicant does not believe that any fee is due for the filing of the above documents. However, the Director is hereby authorized to charge any fee deficiency for this filing to our Deposit Account No. 50-4056 under Order No. 7601/88288.

It is respectfully requested that the enclosed postcard be stamped with the date the enclosed documents are received by the PTO and that it be returned as soon as possible.

Very truly yours,

LAW OFFICE OF MICHAEL A. SANZO, LLC

Michael A. Sanzo

Michael A. Sanzo
Reg. No. 36,912
Attorney for Applicants



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:

HÄGER, *et al.*

Appl. No.: 10/591,289

Filed: August 31, 2006

For: **High Transparency Laser-Markable
and Laser-Weldable Plastic Materials**

Art Unit: 1714

Examiner: Not Yet Assigned

Atty. Dkt.: 7601/88288

Third Supplemental Information Disclosure Statement

MAIL STOP - AMENDMENT

Commissioner of Patents
U.S. Patent and Trademark Office
P.O. Box 1450
Arlington, Virginia 22131-1450

Sir:

Submitted herewith is a listing of documents known to Applicants and/or their attorney in compliance with the requirements of 37 C.F.R. § 1.56. In order to facilitate review by the Examiner, US patents or published US patent applications were substituted for counterpart foreign applications whenever possible. Copies of the listed documents, with the exception of United States patent references, are also enclosed.

In addition to the documents cited herein, Applicants wish to make the Examiner aware of the following co-pending applications:

10/510,946 filed June 3, 2003;
10/539,132 filed October 18, 2003;
10/546,061 filed March 26, 2004;
10/501,925 filed July 28, 2004;
10/584,464 filed December 1, 2004;
10/528,178 filed March 17, 2005;

10/544,041 filed August 2, 2005;
10/553,967 filed October 19, 2005;
10/571,441 filed June 16, 2005;
11/572,018 filed July 5, 2005;
11/575,409 filed September 30, 2005;
11/720,613 filed November 29, 2005;
11/722,122 filed December 20, 2005;
11/368,602 filed March 7, 2006;
11/748,874 filed May 15, 2007;
11/813,103 filed September 11, 2005;
11/822,862 filed July, 10 2007.

In accordance with 37 C.F.R. §1.98(a)(3), Applicants' undersigned attorney submits the following concise explanation of the relevance of the non-English language documents cited on the accompanying form:

Reference B1, DE 44 07 547 A1, describes a method of marking bodies of transparent material, especially glass, by laser radiation. An English language abstract corresponding to this document is cited on the accompanying list of references as document C1.

Reference B2, DE 10 2004 008 202 describes thermoplastic molding materials useful in preparing things such as fibers, foils and molded articles. The materials comprise: thermoplastic polymers, spherically; organically modified nano-filler materials; and other additives. An English language abstract corresponding to this document is cited on the accompanying list of references as document C2.

Reference B5, WO 2006/072496, describes the use of a molded mass (comprising a copolyamide) for the production of a printable or printed article. An English language abstract corresponding to this document is cited on the accompanying list of references as document C3.

Reference B6, WO 2006/087248, describes a moulding compound comprising a partially crystalline copolyamide and a crystallization auxiliary of metal salts, metal oxides or metal

hydroxides that reacts with carboxyl terminal groups of the copolyamide. The moulding compound may be used for preparing a printed article. An English language abstract corresponding to this document is cited on the accompanying list of references as document C4.

Reference B8, WO 2006/111302, describes a process for making thermoplastic molding materials. The method involves mixing the molding material in a molten state with inorganic particles and solubilizing agents in an extruder. The mixture is then passed into an expansion zone where it is cooled and molded. An English language abstract corresponding to this document is cited on the accompanying list of references as document C5.

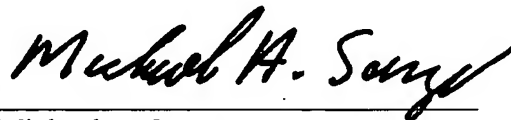
Applicants do not waive any rights to appropriate action to establish patentability over any of the listed documents should they be applied as references against the claims of the present application. This statement should not be construed as a representation that more material information does not exist or that an exhaustive search of the relevant art has been made.

Consideration of the cited documents and making the same of record in the prosecution of the above-captioned application are respectfully requested. Applicants do not believe any fee is due for the submission of this Information Disclosure Statement. However, the Commissioner is hereby authorized to charge any fee deficiency to our Deposit Account No. 50-4056 under Order No. 7601/88288.

Respectfully submitted,

Law Office of Michael A. Sanzo, LLC

By:



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